

TechTalk

Education Inspiration Exchange



**SAMSUNG
ELECTRO-MECHANICS**



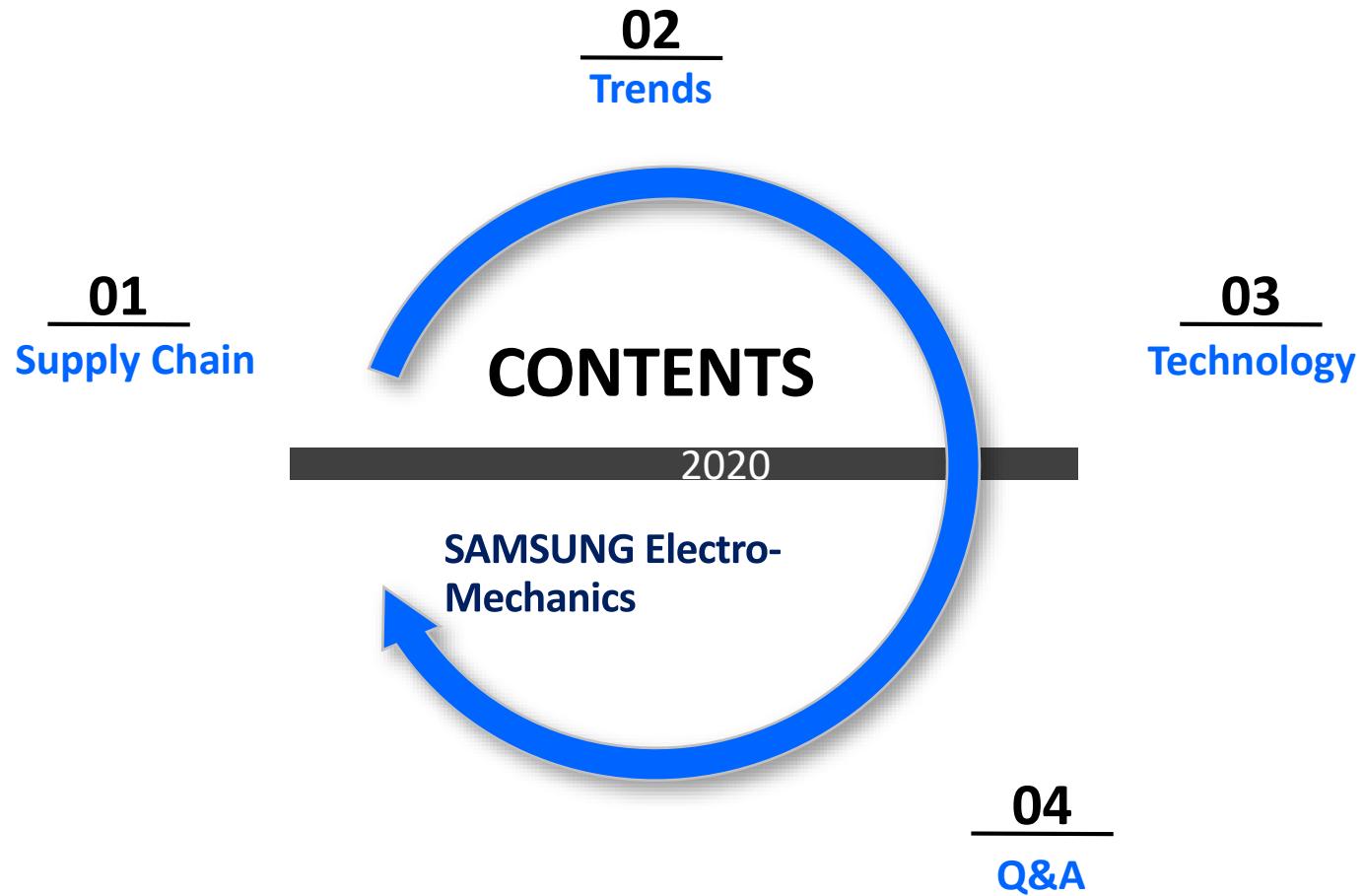
Samsung Electro-Mechanics

Automotive Innovations and their Impact on Ceramic Capacitors

Wasilios Pitharas (Application Engineer)

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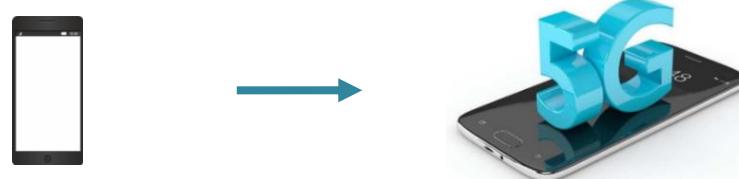
01

Supply Chain

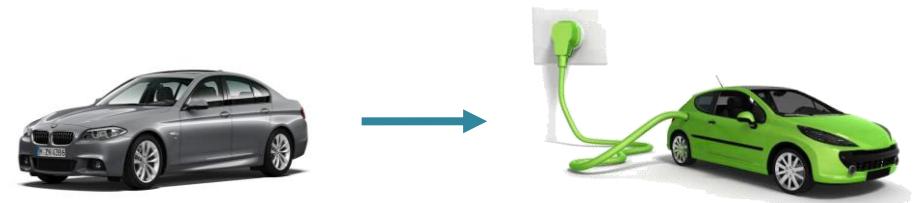
1. Supply Chain

Global Trends

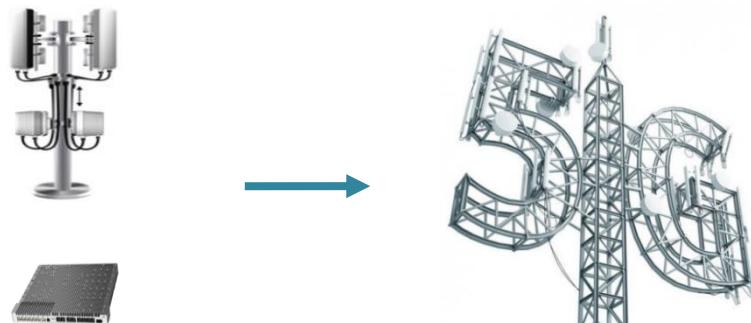
Smart Phone



Automotive



Network

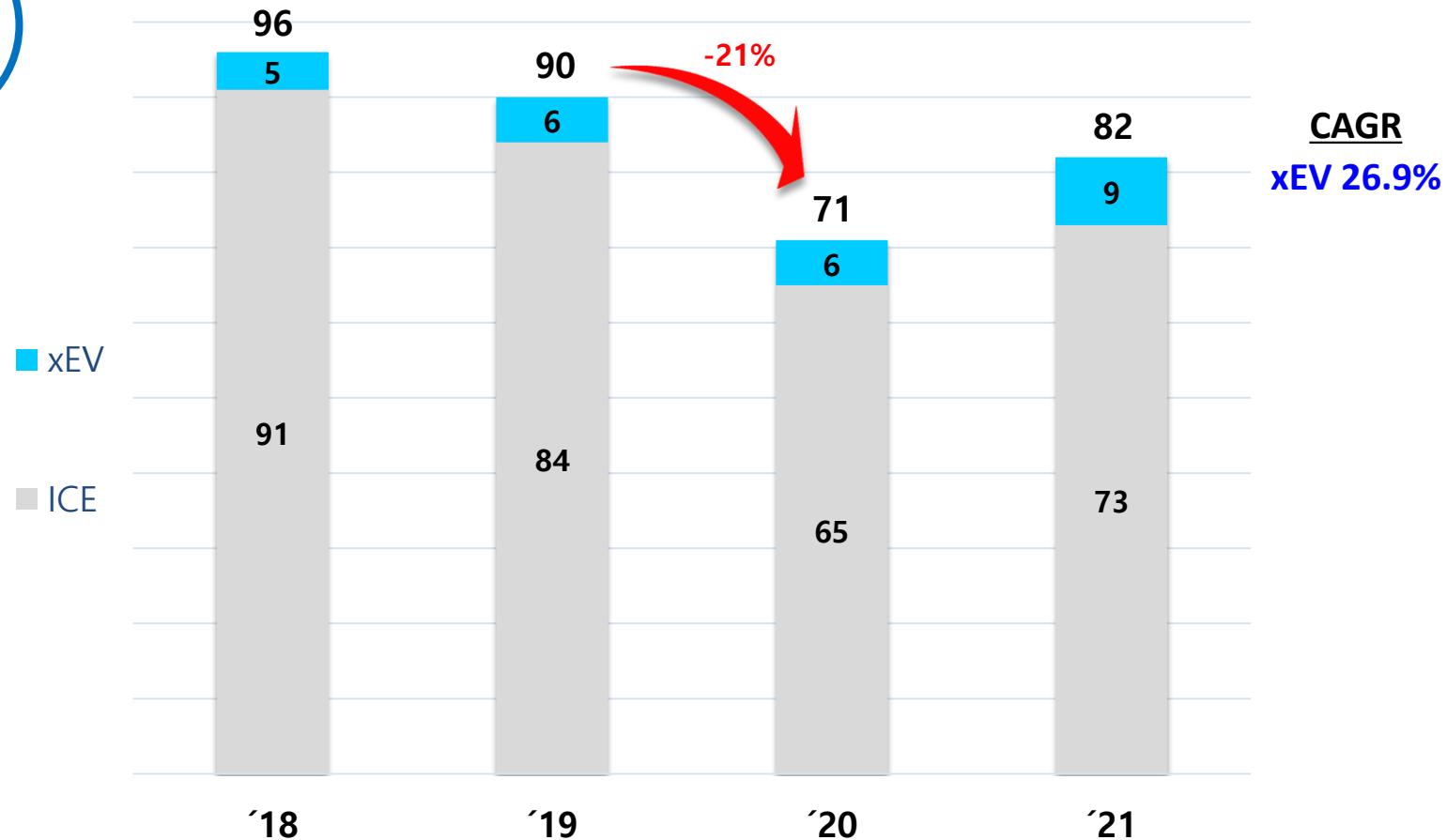


Server



1. Supply Chain

Global Automotive Sales



*xEV includes Battery, Plug-In Hybrid, Hybrid and Fuel Cell

1. Supply Chain

SEMCO Passive Component Factories

TSEM (Tianjin Binhai Factory)



Production : MLCC (1994 ~)



Expanding the capacity for
Automotive MLCC

SEMPHIL (Philippines Factory)



Production : MLCC, PI, Tantal,
Chip Resistor (1997~)

SEMHQ (Suwon & Busan Factory)



Production : MLCC (1986 ~)



Korea
(Suwon, Busan)

● R&D

● Production

Philippines
(Calamba)



Trends

Electrification / Autonomous Driving / Connected Car

Market Mega Trend

① xEV



- Electrification(BMS, VCU, MCU, etc.) ↑
- Increase of Inverter, Converter

② Autonomous Driving



- Driver Assist System Level ↑
- Head lamp, Sensor, Camera, Radar, SPAS
LKAS, ACC, AEB, ILS ESC, EPS ↑

③ Connected Car



- Electrification (HMI, S/W, H/W, Network) ↑
- Display, V2X, HMI, Radio & Car Control Unit ↑



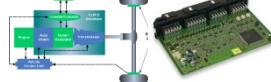
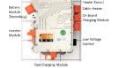
2. Trends

Overview

- Autonomous(or Advanced) Driving

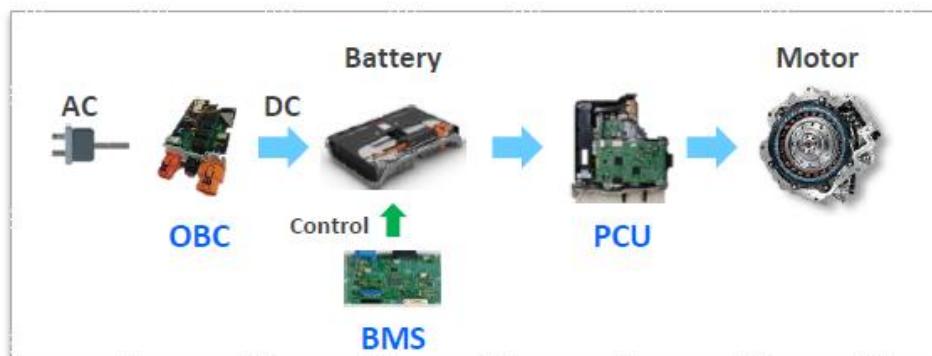
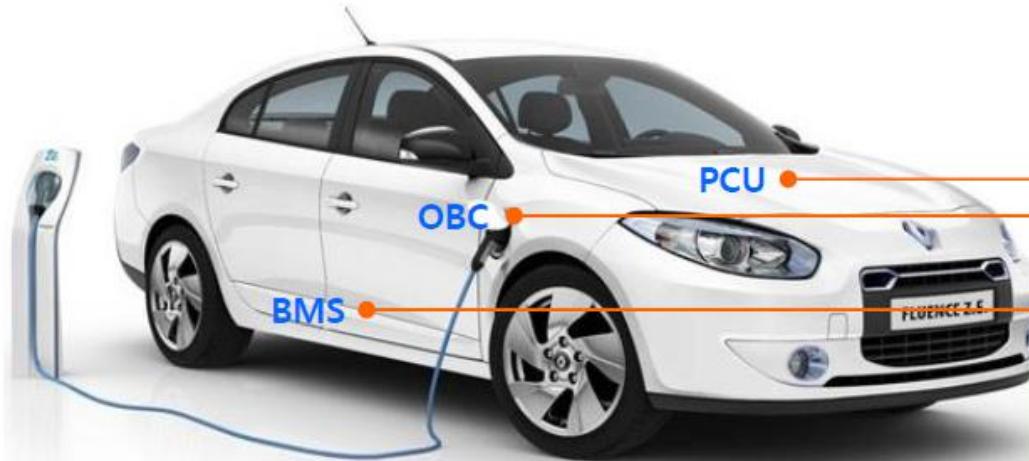
Sensor	Ultrasonic	Camera	IR sensor	Radar	Lidar	Gyro	Impact	TAS	TOS	Position
										
Control	Parking Assistant	LKAS	AEB	ACC	ILS	ADAS Level 3				
										
Function	EPS	ESC	Suspension	Power train	Active seat belt	LED lamp				
										

- xEV

VCU	Motor Control Unit	Battery Pack	On Board Charger	Power Distribution unit	DC-DC converter	Inverter	Regenerative brake system
							

2. Trends

EV



- **Power Control Unit of the vehicle**
 - Motor Driving Unit
 - Consist of control, inverter and LDC(12V) block
 - Smaller ECU Size

- **High voltage battery charging using AC Power**
 - Target car : PHEV, BEV
 - Bidirectional Charge, Fast Charge

- **Battery life and stability management**
 - Battery's cell temperature and Voltage
 - Efficiency ↑ (800V_{Bus}, '25~)

※ PCU: Power Control Unit, BMS: Battery Management System, OBC: On Board Charger, LDWS: Lane Departure Warning System, BCM: Body Control Module

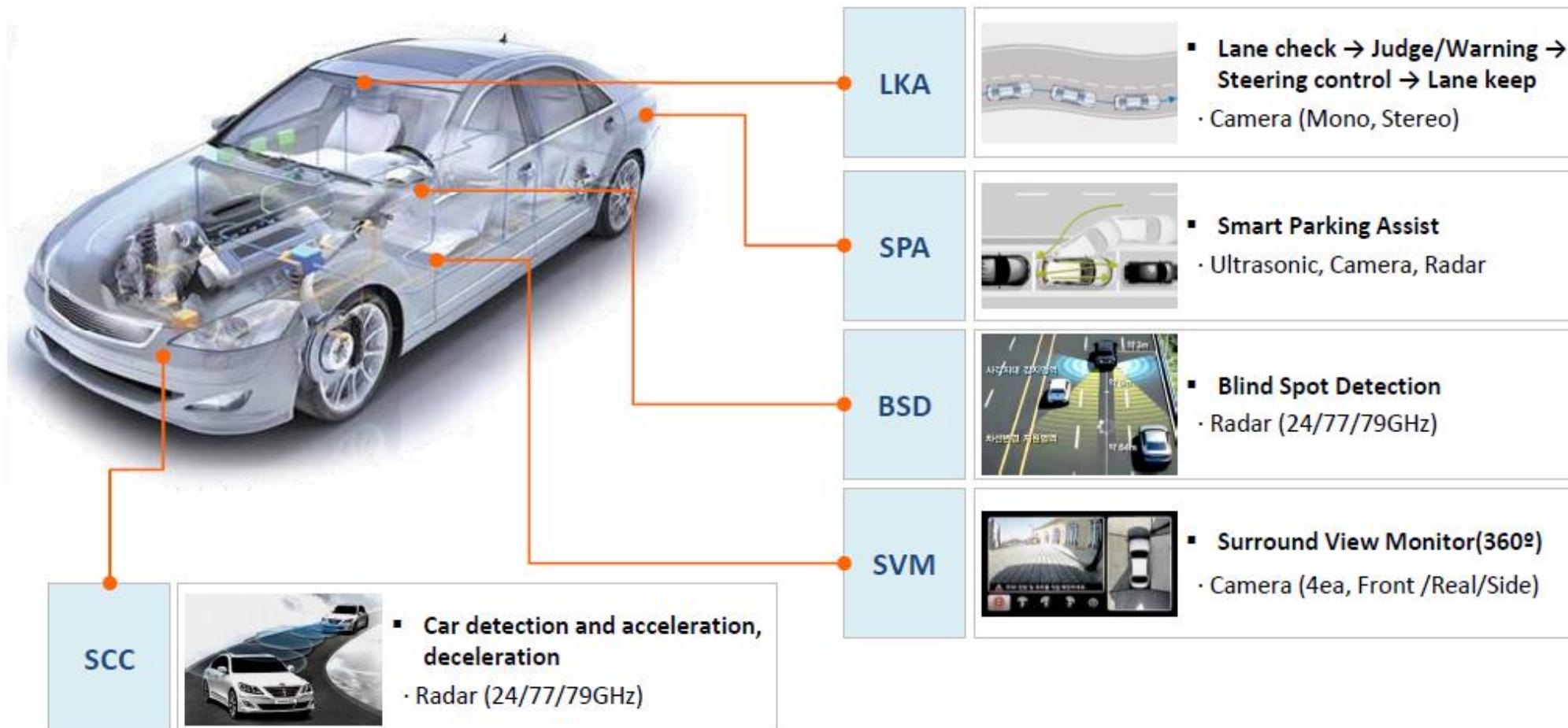
2. Trends

EV

Item	1) ICE	HEV	BEV
Driving force (Engine)	<p>ECU → [Engine] (large)</p>	<p>ECU → [Engine] (medium)</p>	Unused
Driving force (Electric)	<p>*Engine Control Unit</p> <p>Unused</p>	<p>*Power Control Unit</p> <p>PCU → Engine (medium) ← Motor (small)</p> <p>BMS → Battery (small)</p> <p>*Battery Management System</p>	<p>PCU → Engine (large) ← Motor (large)</p> <p>BMS → Battery (large)</p> <p>OBC → Battery (large)</p> <p>*On Board Charger</p>
MLCC (ea)	500~700	1,300~1,700	1,900~2,300
Advantage	High Power	High fuel efficiency	CO ₂ and hazardous gas is none Simple System
Limit	CO ₂ /Hazardous gas big	Complex system	Long battery charging time
Social/ Environmental	Enhance Envir. regulation, Fossil fuels exhaust		Dependence of battery-tech. growth and rare-earth element

2. Trends

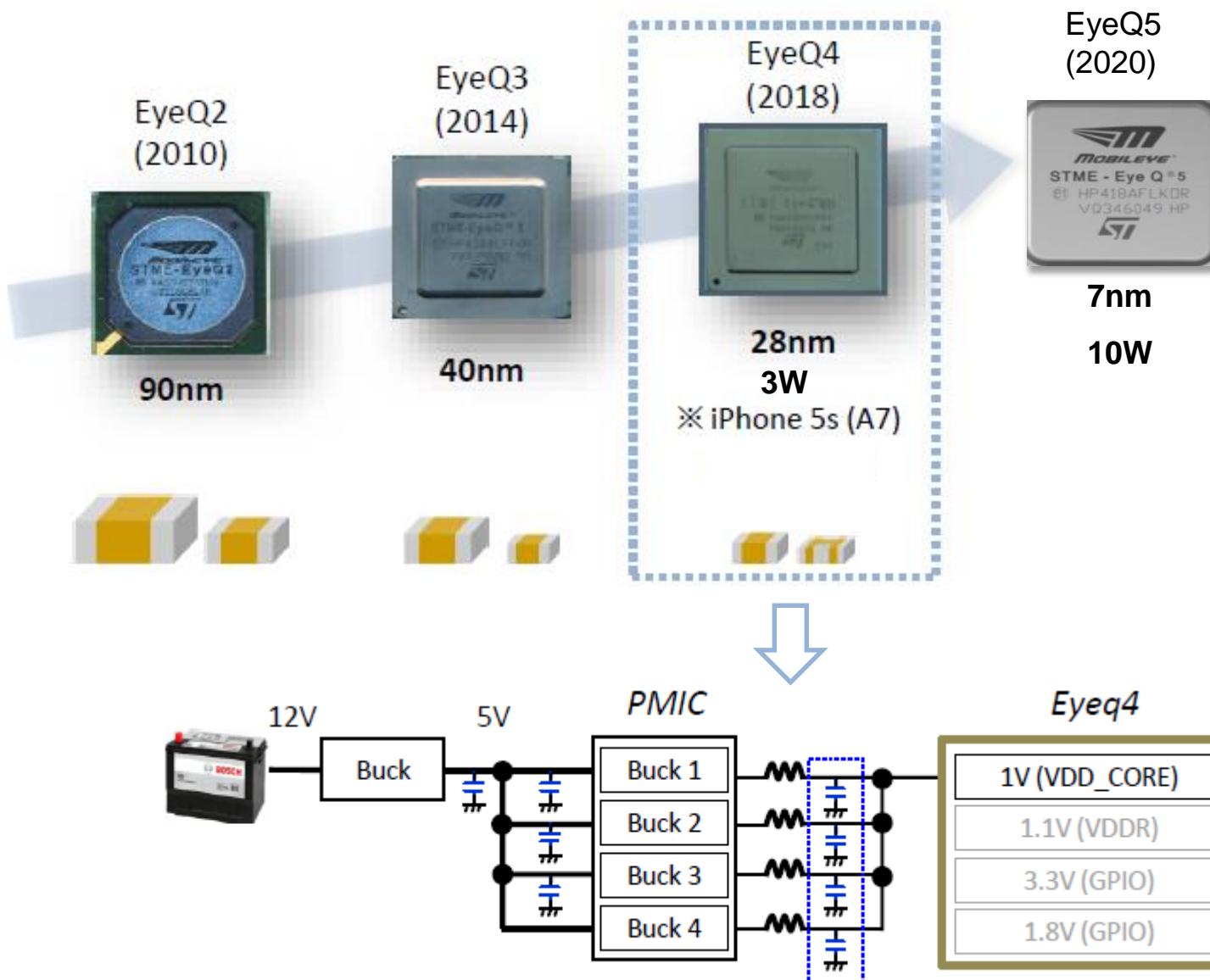
ADAS



※ Reference document : IHS, Automotive ECU market database (2019.3), Hyundai MOBIS homepage

2. Trends

ADAS





Technology

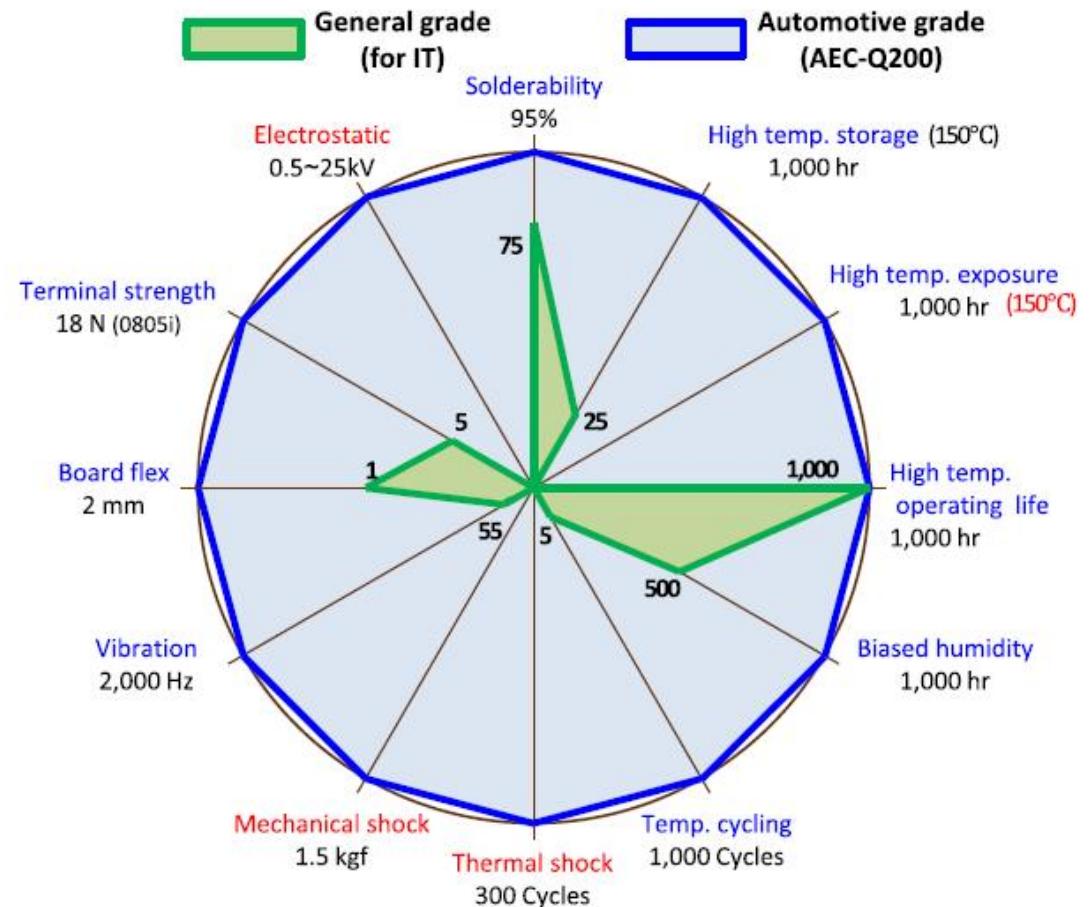
3. Technology

Reliability Requirements

【 Mobile - Environment 】



【 Automotive - Environment 】



【 IT vs Automotive 】

3. Technology

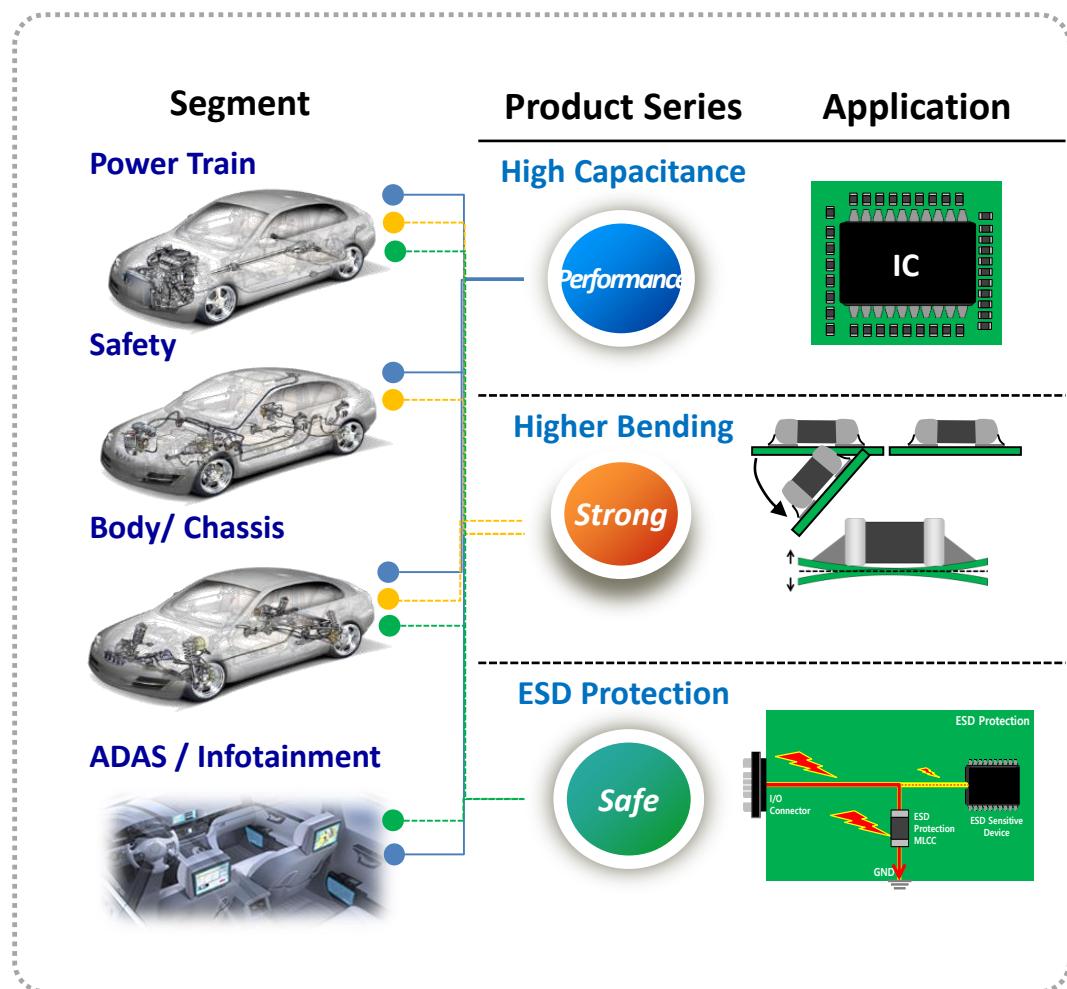
Part Number Explanation

Series										
CL MLCC	10 Size	B Dielectric	104 Cap.	K Tolerance	B Voltage	8 Thickness	N Design	N Termination	N Control	C Packaging
02=01005 "	A= X5R	2 significant digits	B= ±0.1pF	R= 4V	5= 0.50mm	N =Standard	NN= Standard			Cardboard Tape
03=0201"	B= X7R		C= ±0.25pF	Q= 6.3V	6= 0.60mm	S= Soft Term	NW= Industrial			C= 7"Reel
05=0402"	C= C0G		D= ±0.5pF	P= 10V	8= 0.80mm	V=AEC-Q200	W6=Industrial soft			(standard for t<1mm)
10=0603"	X= X6S + Y= X7S		F= ±1pF or G= ±2%	O= 16V A= 25V	C= 0.85mm P= 1.15mm	PN=Automotive	PJ= Automotive			D/L= 13"Reel
21=0805"	Z= X7T	number of zeros	J= ±5% K= ±10%	B= 50V C= 100V D= 200V	F= 1.25mm H= 1.60mm I= 2.00mm	W=AEC-Q200& Open mode	5mm board Flex			Embossed Plastic
31=1206"	G= X8G	use "R" denotes decimal point	M= ±20%	E= 250V H= 630V I= 1000V	J= 2.50mm	4 & 5 = NRND	PE=Automotive ESD Protection			E= 7" Reel (standard for t>1mm)
32=1210"	E= X8L									F= 13"Reel
										Other
										B=Bulk

3. Technology

Automotive MLCC Overview

▪ Higher Capacitance, Fail-safe and Miniaturization



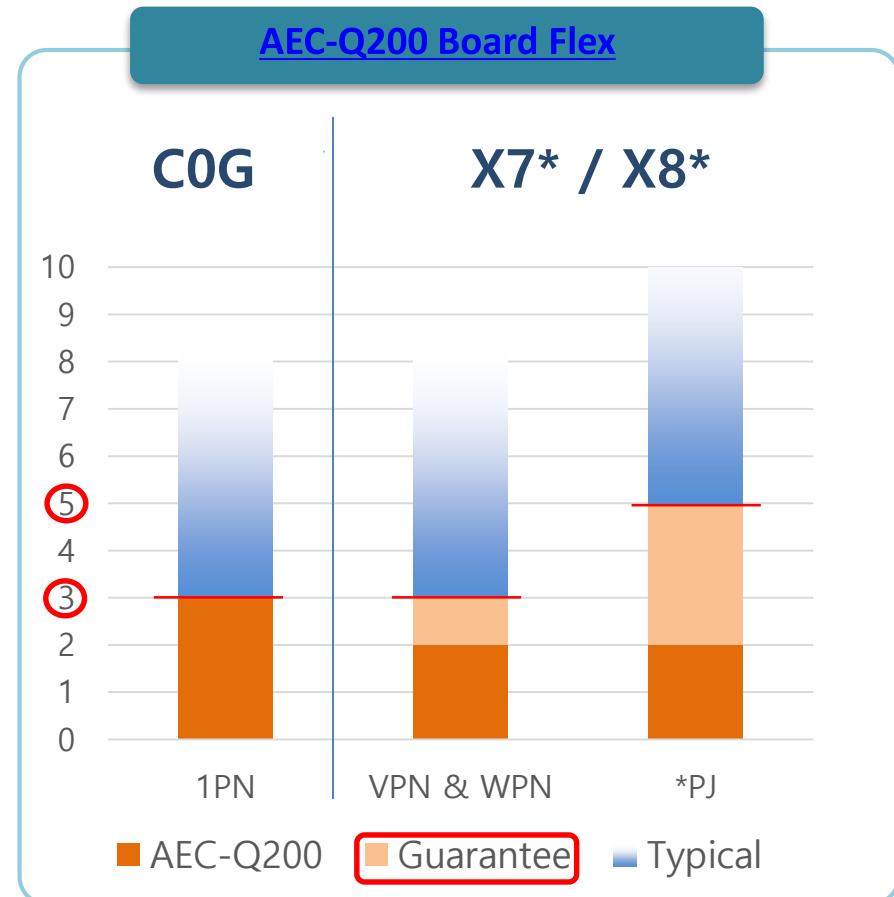
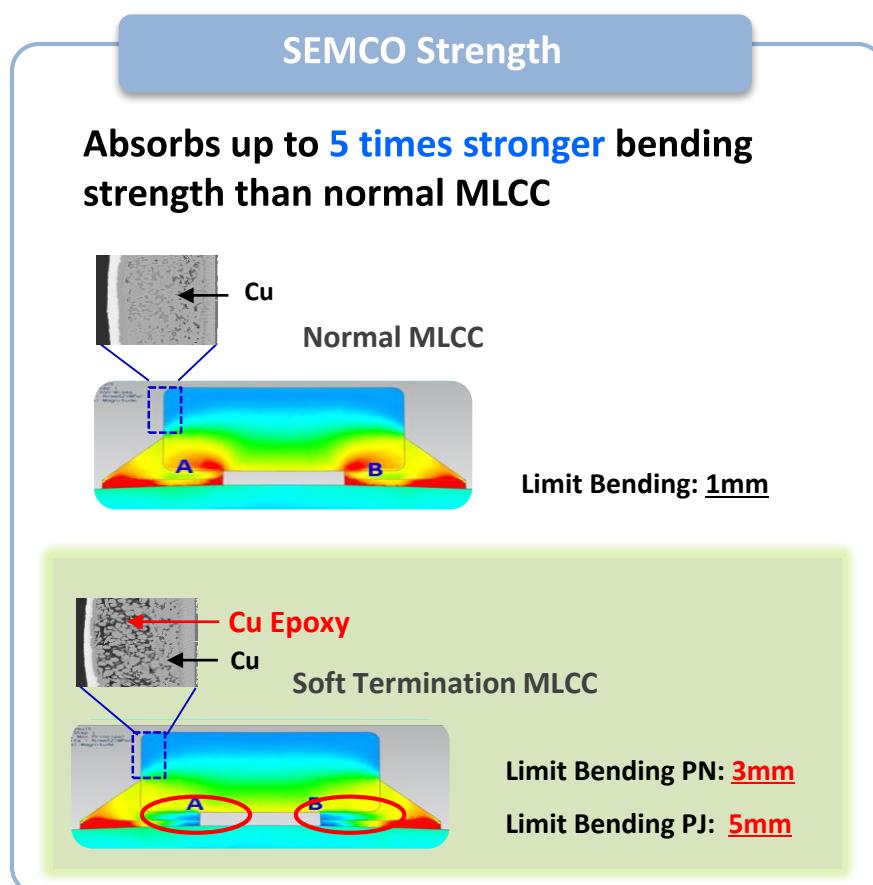
Competitiveness	Line-up
PN <ul style="list-style-type: none">➤ Fine powder technology➤ Strong thermo-mechanical properties	0402~1210 size ~47uF <ul style="list-style-type: none">(inch) 0.1uF 0.47uF 1uF 2.2uF 4.7uF 10uF 22uF0402 0603 0805 1206 1210
PJ <ul style="list-style-type: none">➤ Higher bending strength guarantee(~5mm)➤ VW 80808 compliant	0402~1210 size ~47uF <ul style="list-style-type: none">(inch) 1nF 10nF 0.1uF 0.22uF 0.47uF 1uF 2.2uF 4.7uF 10uF 22uF0402 0603 0805 1206 1210
PE <ul style="list-style-type: none">➤ IEC 61000-4-2 STD compliant➤ Higher ESD voltage	0603 100V 1nF~10nF <ul style="list-style-type: none">(in mm) 1nF 2.2nF 4.7nF 6.8nF 10nF1608 100V <p><< New Product>></p>

This section provides a detailed comparison of three product lines: PN, PJ, and PE. Each line is characterized by its competitiveness, line-up, and specific features. The PN line emphasizes fine powder technology and strong mechanical properties. The PJ line focuses on higher bending strength and VW 80808 compliance. The PE line is IEC 61000-4-2 STD compliant and offers higher ESD voltage. Each line-up table includes a chart showing available sizes and quantities (MP-WPN, Open Model vs MP-VPN, Normal Design).

3. Technology

Termination – PN/PJ

Solution for stress-absorption – Metal Epoxy Termination – VW80808-2 Compliant



3. Technology

PN Series (CLASS II X7R/X7S/X7T)

Size (mm)	RV (V)	Capacitance (nF)										Capacitance (μ F)					
		1	2.2	4.7	10	22	47	100	220	470	1	2.2	4.7	10	22	47	
0402 (1005)	100																
	50																
	25									1							
	16																
	10																
	6.3																
0603 (1608)	100							1									
	50																
	25																
	16																
	10																
	6.3																
0805 (2012)	100				1						1						
	50											1	1				
	25												1		2		
	16																
	10																
	6.3																
1206 (3216)	100								1	1							
	50													1			
	25																
	16																
	10																
	6.3														2		
1210 (3225)	100										1	1					
	50												1				
	25													1			
	16																
	10																
	6.3																

*1 : New Product *2 : SPL available. Please contact us.



04

Q&A

Thank you

Appendix

Appendix

Web-site supports

SEMCO Web-site supports for Customer Engineers

Homepage main : <http://www.samsungsem.com/>

Component library : <http://weblib.samsungsem.com>

Product Search : <http://product.samsungsem.com>

SEMCO Web site (Component biz.)



Component Library

- S-parameter and Spice Model of MLCC/Inductor
 - Characteristics of MLCC according to Temperature and DC bias
 - Temperature rise and Inductance of Power Inductor according to DC Current
 - Converter Simulation tool

